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RF360 Europe GmbH

Data sheet

SAW Rx filter Automotive telematics LTE band 29

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Ordering code:	B39721B2603P810

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- 1 Application
- Low-loss RF filter for LTE Band 29 systems (RX)
- Usable pass band 11 MHz
- No matching network required for operation at 50 Ω

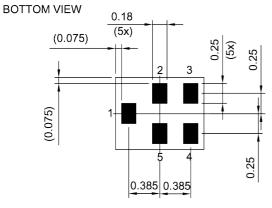
2 Features

- Package size 1.1±0.1 mm × 0.9±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 2 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)



Figure 1: Picture of component with example of product marking.

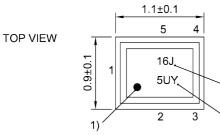
3 Package



Pad and pitch tolerance ±0.05

SIDE VIEW



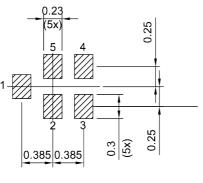


- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

3)

2)

Land pattern THRU VIEW



Landing pad tolerance -0.02**Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 18).

4 Pin configuration

- 1 Input
- 4 Output
- 2, 3, 5 Ground



5 Matching circuit

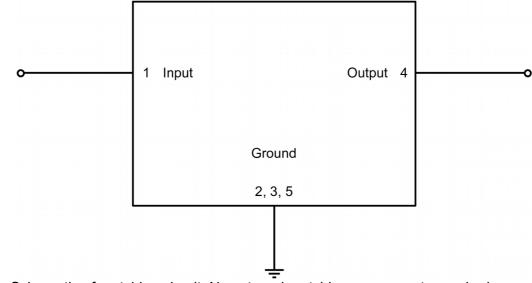


Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification	$T_{_{\rm SPEC}}$	= −20 °C +90 °C
Input terminating impedance	Z _{IN}	= 50 Ω
Output terminating impedance	Z _{OUT}	= 50 Ω

Characteristics				min. for $T_{\rm SPEC}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f _c	—	722.5	—	MHz
Maximum insertion attenuation			α _{max}				
	717 728	MHz		—	1.8	2.5	dB
Amplitude ripple (p-p)			Δα				
	717 728	MHz		—	0.4	1.1	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	717 728	MHz		—	1.6	2.0	
@ output port	717 728	MHz		—	1.5	2.0	
Minimum attenuation							
	10 698	MHz	$\alpha_{_{min}}$	40	44	_	dB
	698 705	MHz	$\alpha_{_{min}}$	35	45	—	dB
	705 710	MHz	$lpha_{INT,min}^{1)}$	15	21	—	dB
	734 739	MHz	$\alpha_{\rm INT,min}^{~~1)}$	10	19	—	dB
	739 746	MHz	$\alpha_{_{min}}$	23	27	—	dB
	746 750	MHz	$\alpha_{_{min}}$	35	39	—	dB
	750 6000	MHz	$\alpha_{_{min}}$	30	34	—	dB
	1428 3000	MHz	$\alpha_{_{min}}$	36	39	—	dB
	1710 1755	MHz	$\alpha_{_{min}}$	40	46	_	dB
	1850 1910	MHz	$\alpha_{_{min}}$	40	45	—	dB
	2151.75 2183.35	MHz	$\alpha_{_{min}}$	40	43	—	dB
	2400 2500	MHz	$\alpha_{_{min}}$	38	41	—	dB
	4900 5950	MHz	$\alpha_{_{min}}$	30	34	—	dB

¹⁾ Integrated over 5 MHz.

7 **Maximum ratings**

Operable temperature	T _{OP} = −40 °C +125 °C	
Storage temperature	$T_{\rm STG}^{1)} = -40 ^{\circ}{\rm C} \dots +125 ^{\circ}{\rm C}$	
DC voltage	$ V_{\rm DC} ^{2)} = 0 V (max.)$	
Input power @ input port: 717 728 MHz	P _{IN} = 15 dBm	Continuous wave for 5000 h @ 50 °C.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C. In case of applied DC voltage blocking capacitors are mandatory. 1)

2)



8 Transmission coefficient

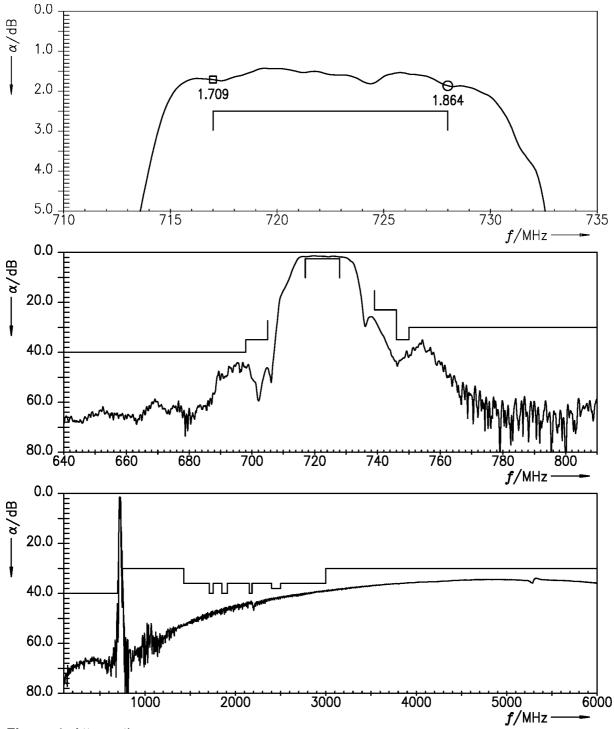


Figure 4: Attenuation.

Please read **Cautions and warnings** and **Important notes** at the end of this document.



□ = 717.0 O = 728.0

*Z*_{IN}=50 Ω

9 Reflection coefficients

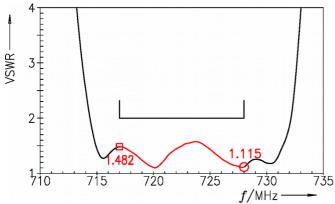


Figure 5: Reflection coefficient at input port.

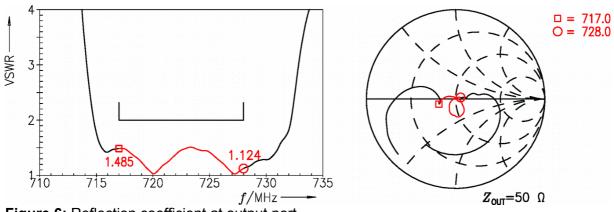
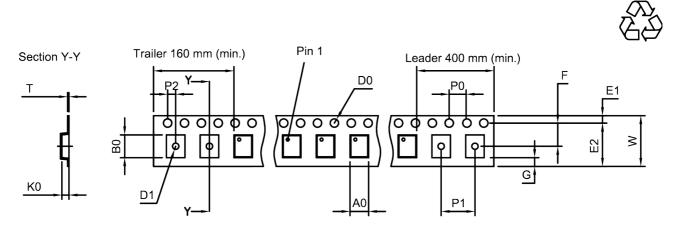


Figure 6: Reflection coefficient at output port.



10 Packing material

10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

E₂ 6.25 mm (min.)

 $\begin{array}{c|c} A_0 & 1.02 \pm 0.05 \text{ mm} \\ \hline B_0 & 1.22 \pm 0.05 \text{ mm} \\ \hline D_0 & 1.55 \pm 0.05 \text{ mm} \\ \hline D_1 & 0.55 \pm 0.1 \text{ mm} \\ \hline E_1 & 1.75 \pm 0.1 \text{ mm} \end{array}$

F	-	3.5±0.05 mm
C	3	-
K	0	0.6±0.05 mm
Ρ	0	4.0±0.1 mm
-		

P ₁	2.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

Table 1: Tape dimensions.



10.2 Reel with diameter of 180 mm

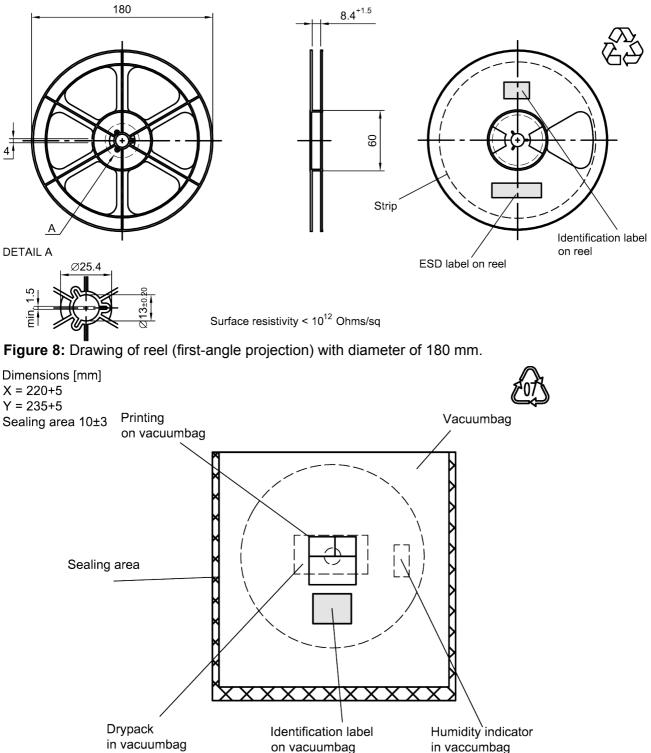
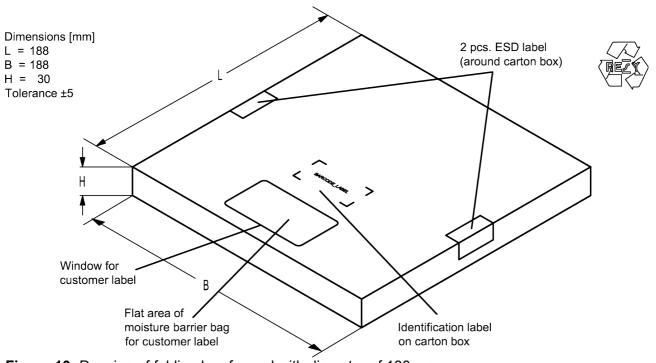
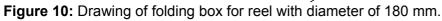


Figure 9: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

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11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit marking.		e.g., B3xxxxB <u>1234</u> xxxx,
Example of decoding 16J 1 x 32 ² + 6 x The BASE32 code for pro-	type number marking on device => 32 ¹ + 18 (=J) x 32 ⁰ = oduct type B2603 is 2HB.	in decimal code. 1234 1234

■ Lot number:

The last 5 digits of the lot number,e.g.,**12345**,are encoded based on a special BASE47 code into a 3 digit marking.12345,

Example of decoding lot number marking on device **5UY**

5 x 47² + **27** (=U) x 47¹ + **31** (=Y) x 47⁰

	in decimal code.
=>	12345
=	12345

Adopte	Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	K	
4	4	20	М	
5	5	21	Ν	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	А	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	Х
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	К	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

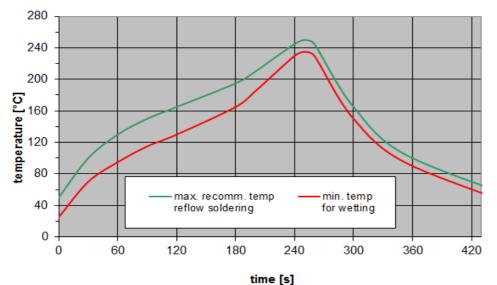


Figure 11: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 ESD protection of SAW filters

SAW filters are Electro Static Discharge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

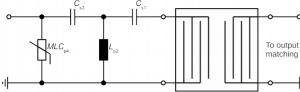


Figure 12: MLC varistor plus ESD matching.

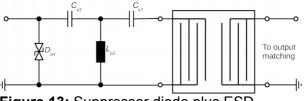


Figure 13: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

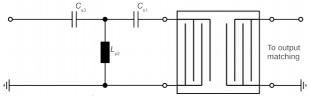


Figure 14: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor L_{p2} could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: **"ESD protection for SAW filters".** This report can be found under <u>https://rffe.qualcomm.com</u>.

14 Annotations

14.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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